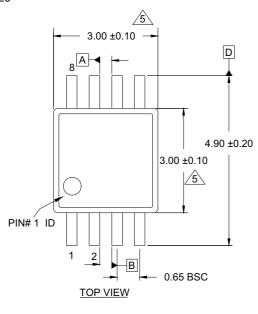
## **Plastic Packages for Integrated Circuits**

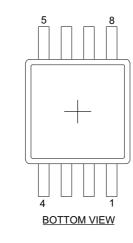
## **Package Outline Drawing**

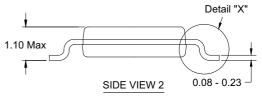
M8.118D

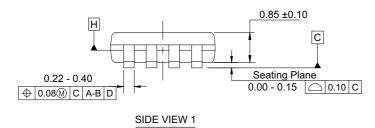
8 Lead Mini Small Outline Plastic Package (MSOP)

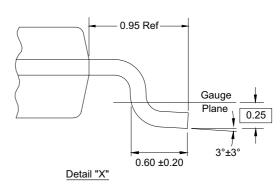
Rev 2, 9/2023

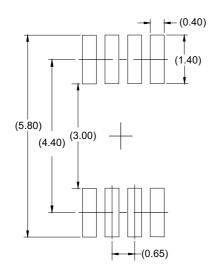












## NOTES:

- 1. Dimensions are in millimeters.
- 2. Dimensioning and tolerancing conform to JEDEC MO-187-AA and ASME Y14.5m-1994.
- Plastic or metal protrusions of 0.15mm max per side are not included.
- 4. Plastic interlead protrusions of 0.15mm max per side are not included.
- 5. Dimensions are measured at Datum Plane "H".
- 6. Dimensions in ( ) are for reference only.

TYPICAL RECOMMENDED LAND PATTERN